Description

The seven band graphic equalizer IC is a CMOS chip that divides the audio spectrum into seven bands, 63Hz, 160Hz, 400Hz, 1kHz, 2.5kHz, 6.25kHz and 16kHz. The seven frequencies are peak detected and multiplexed to the output to provide a DC representation of the amplitude of each band. No external components are needed to select the filter responses. Only an off chip resistor and capacitor are needed to select the on chip clock oscillator frequency. The filter center frequencies track this frequency.

Other than coupling and decoupling capacitors, no other external components are needed. The chip supply can be between 2.7 and 5.5 volts with 5 volts providing the best performance. The device has very low quiescent current (less than 1mA typical) for portable audio devices. The multiplexor is controlled by a reset and a strobe, permitting multiplexor readout with only two pins. The multiplexor readout rate also controls the decay time (10% decay per read), so no external pins are needed for this function.

Features_

Low Power Consumption Only Two External Components On Chip Ground Reference Switched - Capacitor Filters 3.3 or 5 volt Operation 20 dB of Gain Typical On Chip Oscillator Output Multiplexor Variable Decay Time 8 Pin Package

Applications_

Portable Stereos Car Stereos Hi-Fi Stereos Spectrum Analyzers

Absolute Maximum Ratings—

Power Supply Voltage Storage Temperature Operating Temperature +6V -60 to + 150 C 0 to 70 C



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Electrical Characteristics____

 $(VDD = +5.0V, T = 25^{\circ}C)$

SYMBOL	CONDITIONS		TYP	MAX	UNITS
•		•			
VDD		2.7	5.0	5.5	V
IDD	1 Mohm Load on Output	0.5	0.8	1.0	mA
IO			1		mA
ZO			700		ohms
VOS				600	mV
	Same device			200	mV
AV	Peak input to DC output, Vin = 100 mVpp, fin = 1 kHz	20	22	24	dB
Q		5.5	6.0	6.5	
	Vin = 0.3Vpp, fin = 1 kHz	3.5	4		V
FCLK	C = 33 pF*, R = 200 kohms	145	165	180	kHz
ZIN		1			Mohm
	SYMBOL VDD IDD IO ZO VOS VOS AV Q E FCLK ZIN	SYMBOL CONDITIONS VDD 1 IDD 1 IDD 1 IO 20 ZO 20 VOS 3 VOS 4 AV Peak input to DC output, Vin = 100 mVpp, fin = 1 kHz Q 10 Vin = 0.3Vpp, fin = 1 kHz FCLK C = 33 pF*, R = 200 kohms ZIN 2	SYMBOL CONDITIONS MIN VDD 2.7 IDD 1 Mohm Load on Output 0.5 IO	SYMBOL CONDITIONS MIN TYP VDD 2.7 5.0 IDD 1 Mohm Load on Output 0.5 0.8 IO 1 Mohm Load on Output 0.5 0.8 IO 1 Mohm Load on Output 0.5 0.8 IO 1 Mohm Load on Output 0.5 0.8 VOS 700 700 VOS 5 700 VOS 20 22 AV Peak input to DC output, Vin = 100 mVpp, fin = 1 kHz 20 22 Q 5.5 6.0 Vin = 0.3Vpp, fin = 1 kHz 3.5 4 FCLK C = 33 pF*, R = 200 kohms 145 165 ZIN 1 1 1 1	SYMBOL CONDITIONS MIN TYP MAX VDD 2.7 5.0 5.5 IDD 1 Mohm Load 0.5 0.8 1.0 IO 1 Mohm Load 0.5 0.8 1.0 IO 1 Mohm Load 0.5 0.8 1.0 ZO 700 700 700 600 600 600 VOS Same device 200 20 22 24 AV Peak input to DC output, Vin = 100 mVpp, fin = 1 kHz 20 22 24 Q 5.5 6.0 6.5 6.5 Vin = 0.3Vpp, fin = 1 kHz 3.5 4 4 FCLK C = 33 pF*, R = 200 kohms 145 165 180 ZIN 1 1 1 1

* includes stray capacitance



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Pin Description_

1.	VDD	Positive Power Supply Typically 5 Volts
2.	VSS	Negative Power Supply Typically 0 Volts
З		Multiplexed DC Output
0.	001	Multiplexed De output
4.	STROBE	Channel Selection Pin
5.	IN	Audio Input
6.	GND	Internally Generated Ground
		Reference.Typically 2.5V
7.	RESET	Resets Multiplexor
8.	CKIN	Clock Oscillator Pin



Block Diagram_



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Multiplexor Operation——

The DC peak output for measurement is selected using the reset and strobe pins. Reset high resets the multiplexor. Reset low enables the strobe pin. After the first strobe leading edge, 63Hz output is on OUT. Each additional strobe leading edge advances the multiplexor one channel (63Hz, 160Hz, 400Hz, 1kHz, 2.5kHz, 6.25kHz, 16kHz etc.) and this will repeat indefinitely. The multiplexor read rate is also the output decay time control. Each read decays that channel approximately 10%. The strobe timing is shown below:

VDDA 0.1u R2 VSSD 33p CKIN VDDA CLK RESEI VSSA RESET RESET_IN AGND MSGEQ7 GND OUT ου 0.10 VSSA STROBE IN STROBE IN LEFT IN

MSGEQ7

Typical Application

Ordering Information

Part Number	Package	Operating	Temperature
MSGEQ7N	8 Pin 150	mils SOIC	0-70 [°] C
MSGEQ7P	8 Pin 300	mils PDIP	0-70 °C



Strobe Timing Diagram

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